ULTRA LOW CAPACITANCE TVS ARRAY

SOD-323 PACKAGE

DESCRIPTION

The EBLCxxC Series are ultra low capacitance transient voltage suppressor arrays, designed to protect applications such as portable electronics and SMART phones. These devices are available in a bidirectional configuration and are rated at 250 Watts for an 8/20µs waveshape.

The EBLCxxC Series meets IEC 61000-4-2 (ESD) and IEC 61000-4-4 (EFT) requirements. At higher operating frequencies or faster edge rates, insertion loss and signal integrity are a major concern. These devices offer a ultra low capacitance and low leakage current in a miniature SOD-323 package.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
  Exceeds Level 4: Handles 10kV Contact & 25kV Air Discharge
- Compatible with IEC 61000-4-4 (EFT): 40A - 5/50ns
- Compatible with IEC 61000-4-5 (Surge): 24A, 8/20µs - Level 2(Line-Gnd) & Level 3(Line-Line)
- 250 Watts Peak Pulse Power per Line (tp = 8/20µs)
- Replacement for MLV (0805)
- Bidirectional Configuration
- Protects One Power or I/O Port
- Low Clamping Voltage
- Ultra Low Capacitance: 3pF (Typical)
- Available in 5, 8 and 12V
- RoHS Compliant
- REACH Compliant

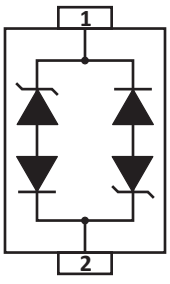
APPLICATIONS

- Ethernet 10/100/1000 Base T
- SMART Phones
- Handheld - Wireless Systems
- USB Interface

MECHANICAL CHARACTERISTICS

- Molded JEDEC SOD-323 Package
- Approximate Weight: 5 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:
  Pure-Tin - Sn, 100: 260-270°C
- 8mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

PIN CONFIGURATION



TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified			
PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power (tp = 8/20µs) - See Figure 1	P_{PP}	250	Watts
Operating Temperature	T_A	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified							
PART NUMBER	DEVICE MARKING	RATED STAND-OFF VOLTAGE V_{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ IP = 1A V_C VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ 8/20µs V_C @ I_{PP}	MAXIMUM LEAKAGE CURRENT @V_{WM} I_D µA	TYPICAL CAPACITANCE @0V, 1MHz C pF
EBLC05C	5A	5.0	6.0	9.8	18.3V @ 17.0A	5	3
EBLC08C	8A	8.0	8.5	13.4	28.0V @ 12.0A	2	3
EBLC12C	12C	12.0	13.3	19.0	31.0V @ 8.0A	1	3

TYPICAL DEVICE CHARACTERISTICS

FIGURE 1
PEAK PULSE POWER VS PULSE TIME

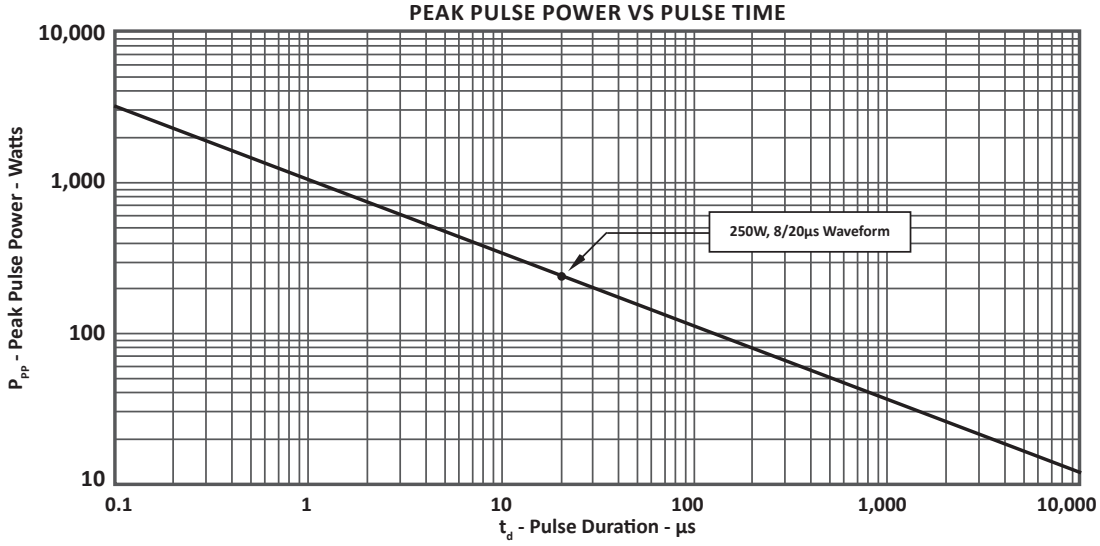
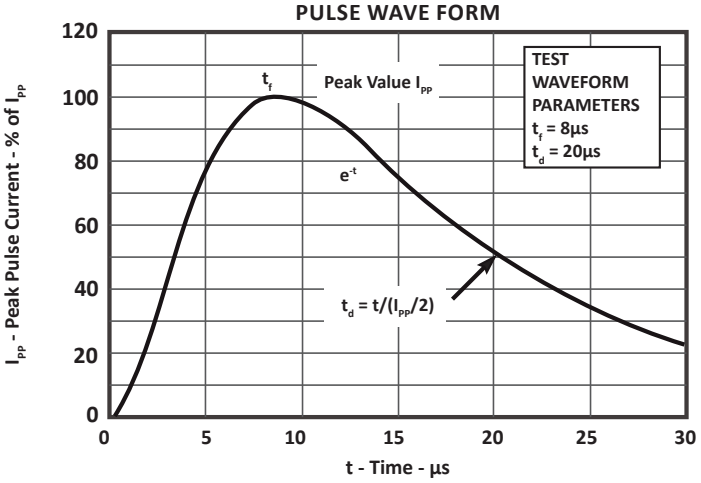


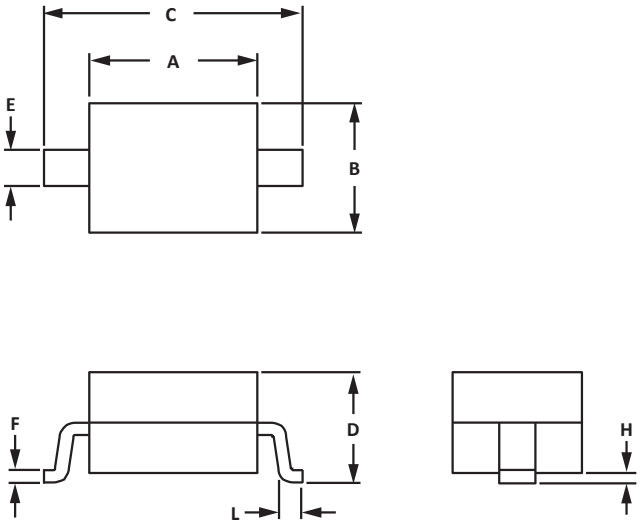
FIGURE 2
PULSE WAVE FORM



SOD-323 PACKAGE INFORMATION

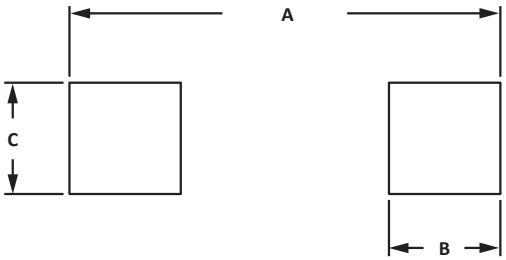
OUTLINE DIMENSIONS				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.60	1.90	0.063	0.075
B	1.15	1.45	0.045	0.057
C	2.39	2.70	0.094	0.106
D	0.80	1.10	0.031	0.043
E	0.25	0.40	0.010	0.016
F	0.10	0.20	0.004	0.008
H	-	0.10	-	0.004
L	0.20	-	0.008	-

NOTES
1. Controlling dimension: millimeters.
2. Dimensioning and tolerances per ANSI Y14.5M, 1985.
3. Dimensions are exclusive of mold flash and metal burrs.

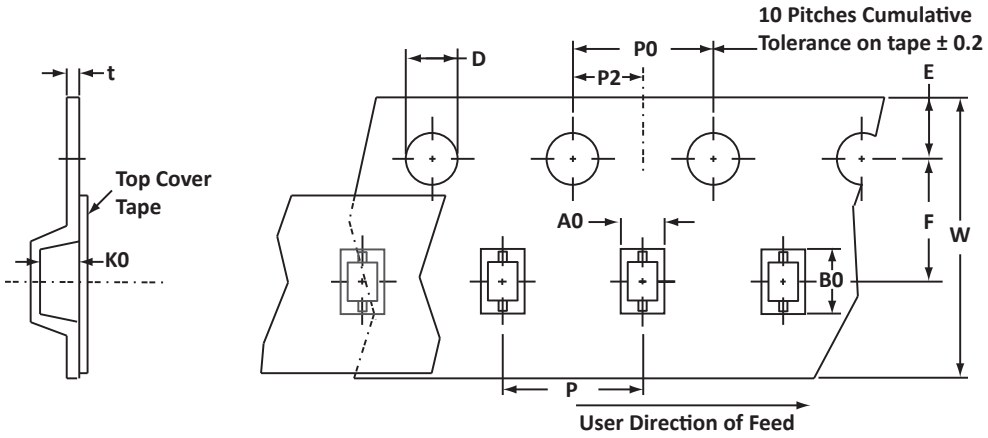


PAD LAYOUT DIMENSIONS				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.87	3.12	0.113	0.123
B	0.66	0.91	0.026	0.036
C	0.66	0.91	0.026	0.036

NOTES
1. Controlling dimension: millimeters.



TAPE AND REEL



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	B0	K0	D	E	F	W	P0	P2	P	tmax
178mm (7")	8mm	1.55 ± 0.10	2.90 ± 0.10	1.35 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	0.25

NOTES
1. Dimensions are in millimeters.
2. Surface mount product is taped and reeled in accordance with EIA-481.
3. Suffix - T7 = 7" Reel - 3,000 pieces per 8mm tape.
4. Marking on Part - marking code (see page 2).

Package outline, pad layout and tape specifications per document number 06010.R4 9/10.

ORDERING INFORMATION					
BASE PART NUMBER (Voltage = xx)	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY
EBLCxxC	n/a	-T7	3,000	7"	n/a

This device is only available in a Lead-Free configuration.

COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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